

**PCN# 20250417002.2
Adding TIEM-PR as additional wafer probe test site
for select devices
Change Notification / Sample Request**

Date: April 17, 2025

To: Mouser PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within 60 days of the date of this notice. Lack of acknowledgement of this notice within 60 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 60 days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

TI values customer engagement and feedback related to TI changes. Customers should contact TI if there are questions or concerns regarding a change notification.

Sincerely,

Change Management Team
SC Business Services

20250417002.2
Change Notification / Sample Request
Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
ISO7742QDBQRQ1	ISO7742QDBQRQ1
ISO6763FQDWWRQ1	NULL
ISO6762FQDWWRQ1	NULL
ISO6762QDWWRQ1	NULL
ISO7762QDBQRQ1	NULL
ISO7761QDBQRQ1	NULL
ISO7742FQDBQRQ1	NULL
ISO7720QDWVRQ1	NULL
ISO7721FQDWVRQ1	NULL
ISO7761FQDBQRQ1	NULL
ISO7760FQDBQRQ1	NULL
ISO6761QDWWRQ1	NULL
ISO7762FQDBQRQ1	NULL
ISO7720FQDWVRQ1	NULL
ISO7731QDBQRQ1	ISO7731QDBQRQ1
ISO7741FQDBQRQ1	ISO7741FQDBQRQ1
ISO7720FQDRQ1	ISO7720FQDRQ1
ISO6720QDWVRQ1	NULL
ISO6721QDWVRQ1	NULL
ISO7720QDRQ1	ISO7720QDRQ1
ISO7721FQDRQ1	ISO7721FQDRQ1
ISO7721QDRQ1	ISO7721QDRQ1
ISO7763FQDBQRQ1	NULL
ISO7740FQDBQRQ1	595-ISO7740FQDBQRQ1
ISO7721QDWVRQ1	NULL
ISO6720FQDWVRQ1	NULL
ISO6721FQDWVRQ1	NULL
ISO7763QDBQRQ1	NULL
ISO7741QDBQRQ1	ISO7741QDBQRQ1
ISO7731FQDBQRQ1	ISO7731FQDBQRQ1

Technical details of this Product Change follow on the next page(s).

PCN Number:	20250417002.2			PCN Date:	April 17, 2025
Title:	Adding TIEM-PR as additional wafer probe test site for select devices				
Customer Contact:	Change Management team		Dept:	Quality Services	
Proposed 1st Ship Date:	October 14, 2025		Estimated Sample Availability:	N/A	
Change Type:					
<input type="checkbox"/> Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Material	
<input type="checkbox"/> Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Process	
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Fab Site	
<input type="checkbox"/> Mechanical Specification	<input checked="" type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Material	
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Process	
PCN Details					
Description of Change:					
Texas Instruments is pleased to announce TIEM-PR as additional wafer probe test site for the devices listed below to support high volume ramps.					
	Current		New		
Probe Test Site	TI CDAT (CD-PR)		TI Melaka (TIEM-PR)		
Test coverage, insertions, conditions will remain consistent with current testing.					
Reason for Change:					
Continuity of supply.					
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):					
None					
Impact on Environmental Ratings:					
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.					
RoHS	REACH		Green Status	IEC 62474	
<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	<input checked="" type="checkbox"/> No Change	
Changes to product identification resulting from this PCN:					
None					
Product Affected:					
ISO6721QDWVRQ1	ISO7762QDBQRQ1	ISO6520QDRQ1			
ISO7721QDWVRQ1	ISO6761FQDWWRQ1	ISO7731FQDBQRQ1			
ISO6720QDWVRQ1	ISO6763QDWWRQ1	ISO7720QDRQ1			
ISO7741QDBQRQ1	ISO7761FQDBQRQ1	ISO7720FQDWVRQ1			
ISO7760QDBQRQ1	ISO7763QDBQRQ1	ISO7721QDRQ1			
ISO7740FQDBQRQ1	ISO7721FQDRQ1	ISO7760FQDBQRQ1			
ISO7730QDBQRQ1	ISO6762QDWWRQ1	ISO6520FQDRQ1			
ISO6521FQDRQ1	ISO6760QDWWRQ1	ISO7763FQDBQRQ1			
ISO6521QDRQ1	ISO6762FQDWWRQ1	ISO7742FQDBQRQ1			
ISO6721FQDWVRQ1	ISO7742QDBQRQ1	ISO6763FQDWWRQ1			
ISO7721FQDWVRQ1	ISO7730FQDBQRQ1	ISO7741FQDBQRQ1			
ISO7720QDWVRQ1	ISO7731QDBQRQ1	ISO7740QDBQRQ1			
ISO6720FQDWVRQ1	ISO7720FQDRQ1	ISO6761QDWWRQ1			
ISO7761QDBQRQ1	ISO7762FQDBQRQ1	ISO6760FQDWWRQ1			

ZVEI ID: SEM-TF-01

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.